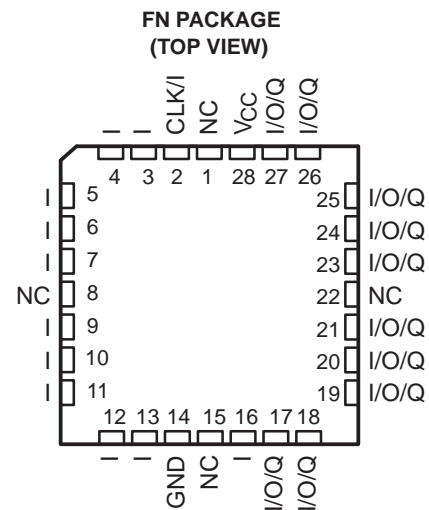
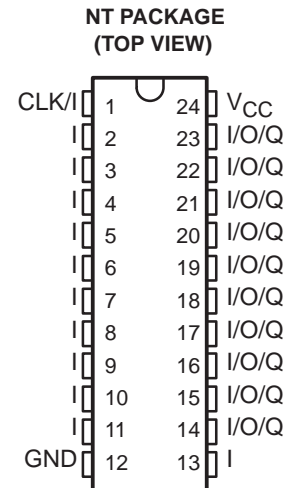


TIBPAL22V10-10C

HIGH-PERFORMANCE *IMPACT-X*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

SRPS015 – D3972, FEBRUARY 1992

- **Second-Generation PLD Architecture**
- **High-Performance Operation:**
 f_{\max} (External Feedback) . . . 71 MHz
 Propagation Delay . . . 10 ns Max
- **Increased Logic Power – Up to 22 Inputs and 10 Outputs**
- **Increased Product Terms – Average of 12 Per Output**
- **Variable Product Term Distribution Allows More Complex Functions to Be Implemented**
- **Each Output Is User Programmable for Registered or Combinational Operation, Polarity, and Output Enable Control**
- **Power-Up Clear on Registered Outputs**
- **TTL-Level Preload for Improved Testability**
- **Extra Terms Provide Logical Synchronous Set and Asynchronous Reset Capability**
- **Fast Programming, High Programming Yield, and Unsurpassed Reliability Ensured Using Ti-W Fuses**
- **AC and DC Testing Done at the Factory Utilizing Special Designed-In Test Features**
- **Dependable Texas Instruments Quality and Reliability**
- **Package Options Include Plastic Dual-In-Line and Chip Carrier Packages**



NC — No internal connection
 Pin assignments in operating mode

description

The TIBPAL22V10-10C is a programmable array logic device featuring high speed and functional equivalency when compared to presently available devices. They are implemented with the familiar sum-of-products (AND-OR) logic structure featuring the new concept "Programmable Output Logic Macrocell". These *IMPACT-X*™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic.

These devices contain up to 22 inputs and 10 outputs. They incorporate the unique capability of defining and programming the architecture of each output on an individual basis. Outputs may be registered or nonregistered and inverting or noninverting as shown in the output logic macrocell diagram. The ten potential outputs are enabled through the use of individual product terms.

Further advantages can be seen in the introduction of variable product term distribution. This technique allocates from 8 to 16 logical product terms to each output for an average of 12 product terms per output. This variable allocation of terms allows far more complex functions to be implemented than in previously available devices.

This device is covered by U.S. Patent 4,410,987.
IMPACT-X is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date.
 Products conform to specifications per the terms of Texas Instruments
 standard warranty. Production processing does not necessarily include
 testing of all parameters.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1992, Texas Instruments Incorporated

TIBPAL22V10-10C

HIGH-PERFORMANCE *IMPACT-X*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

SRPS015 – D3972, FEBRUARY 1992

description (continued)

Circuit design is enhanced by the addition of a synchronous set and an asynchronous reset product term. These functions are common to all registers. When the synchronous set product term is a logic 1, the output registers are loaded with a logic 1 on the next low-to-high clock transition. When the asynchronous reset product term is a logic 1, the output registers are loaded with a logic 0. The output logic level after set or reset depends on the polarity selected during programming. Output registers can be preloaded to any desired state during testing. Preloading permits full logical verification during product testing.

With features such as programmable output logic macrocells and variable product term distribution, the TIBPAL22V10-10C offers quick design and development of custom LSI functions with complexities of 500 to 800 equivalent gates. Since each of the ten output pins may be individually configured as inputs on either a temporary or permanent basis, functions requiring up to 21 inputs and a single output or down to 12 inputs and 10 outputs are possible.

A power-up clear function is supplied that forces all registered outputs to a predetermined state after power is applied to the device. Registered outputs selected as active-low power up with their outputs high. Registered outputs selected as active-high power up with their outputs low.

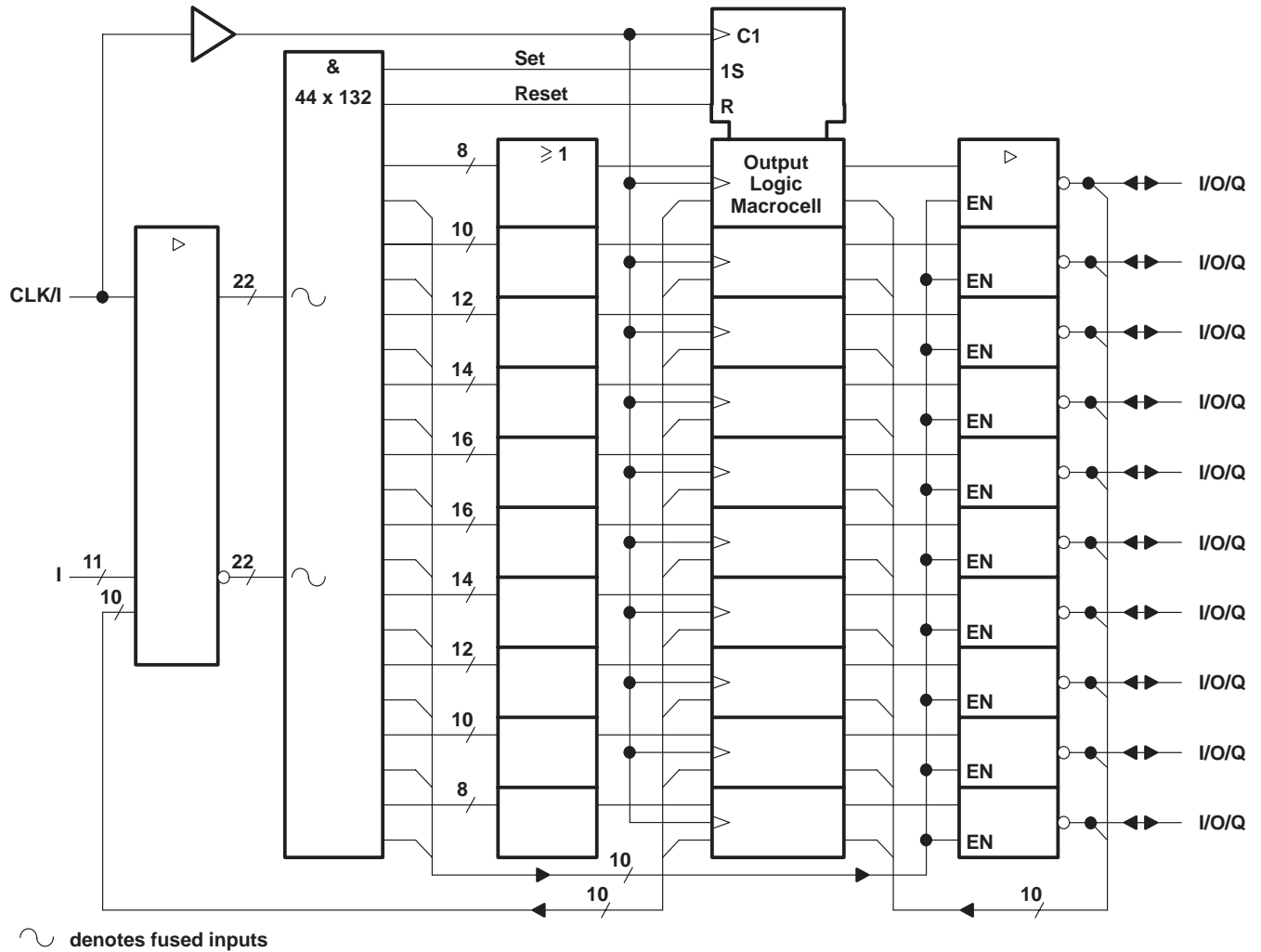
A single security fuse is provided on each device to discourage unauthorized copying of fuse patterns. Once blown, the verification circuitry is disabled and all other fuses will appear to be open.

The TIBPAL22V10-10C is characterized for operation from 0°C to 75°C.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

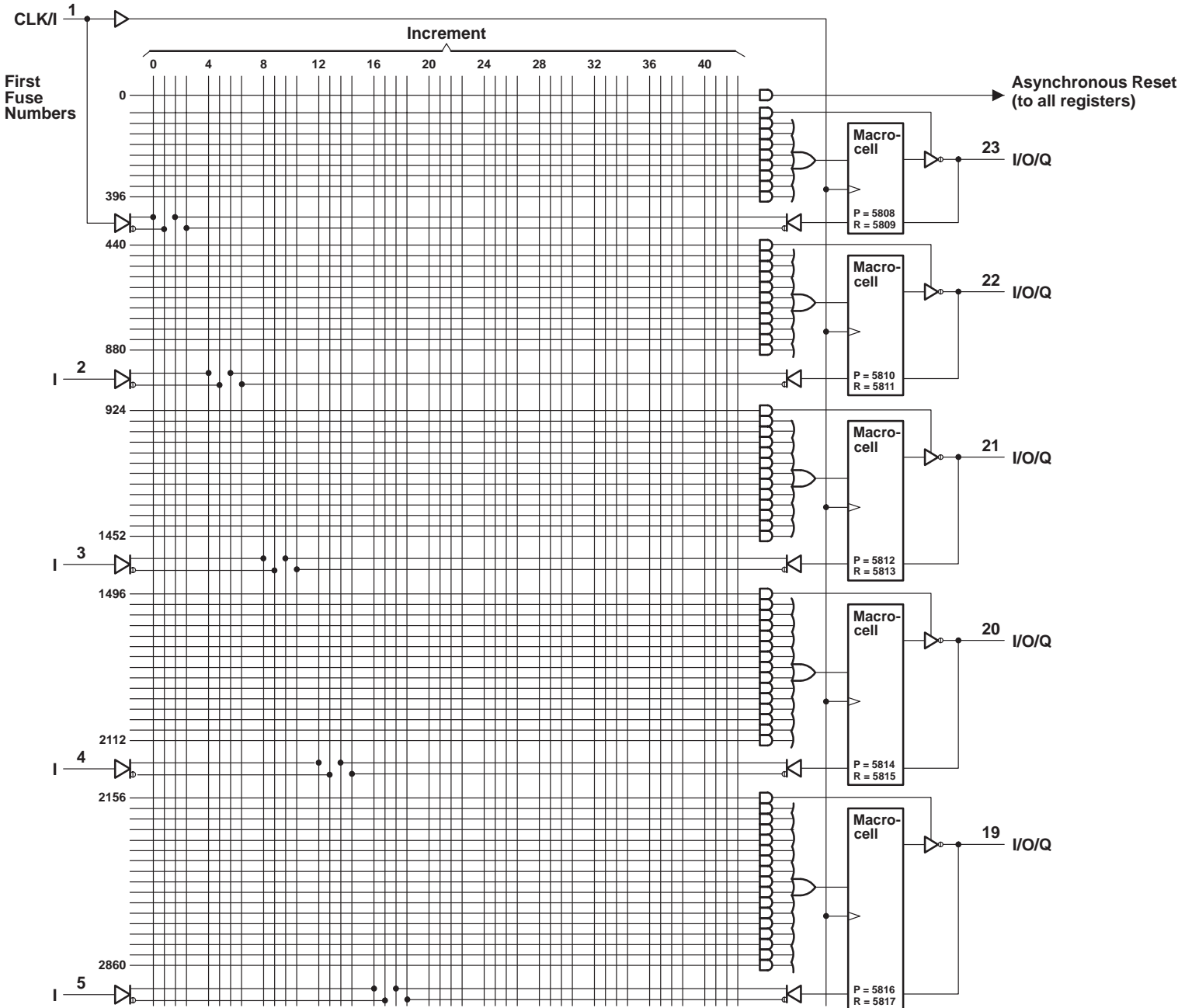
functional block diagram (positive logic)



TIBPAL22V10-10C HIGH-PERFORMANCE IMPACT-X™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

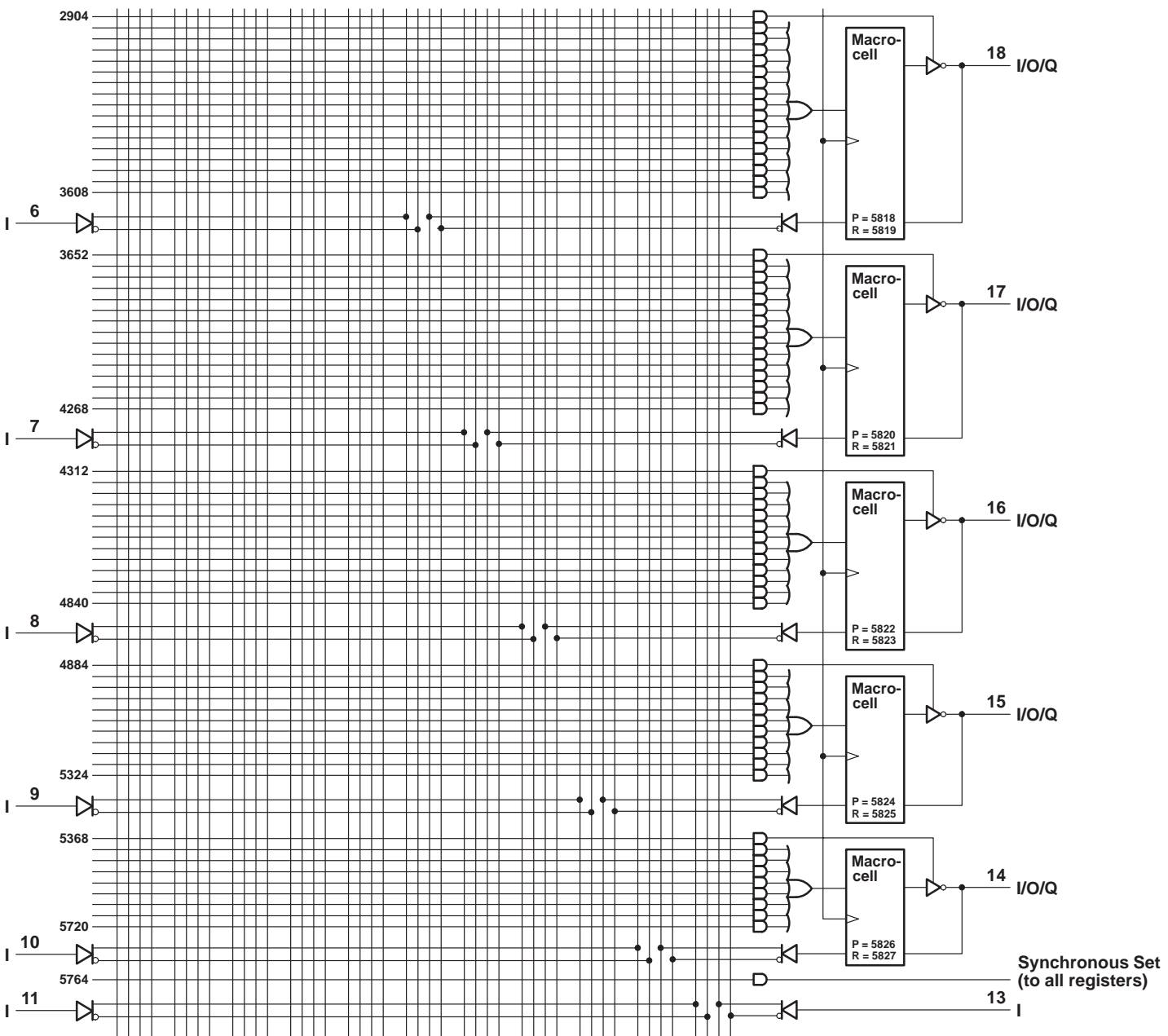
SRPS015 – D3972, FEBRUARY 1992

logic diagram (positive logic)



TIBPAL22V10-10C HIGH-PERFORMANCE IMPACT-X™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

SRPS015 - D3972, FEBRUARY 1992



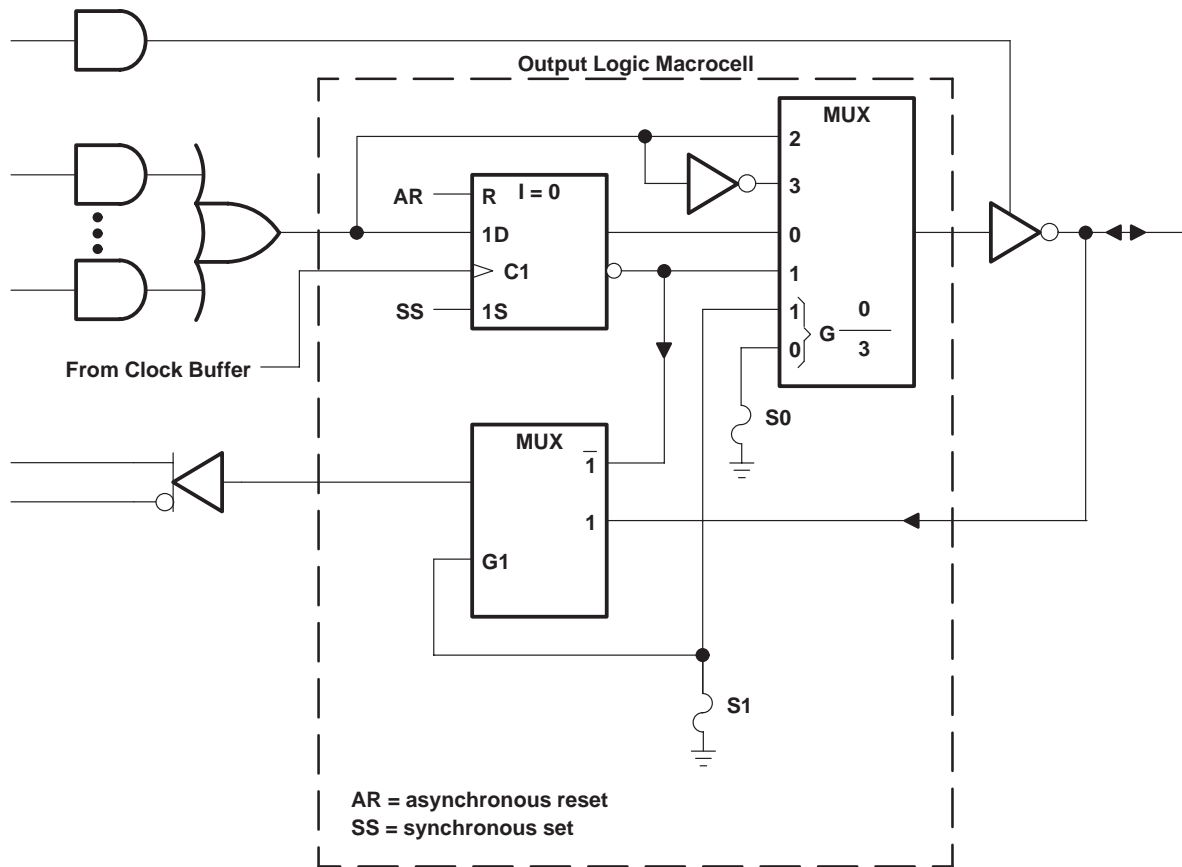
Fuse number = First Fuse number + Increment

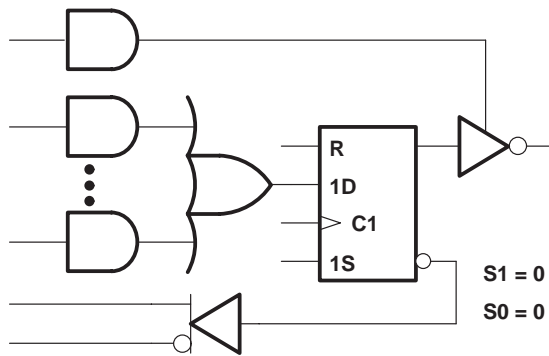
Inside each MACROCELL the "P" fuse is the polarity fuse and the "R" fuse is the register fuse.

TIBPAL22V10-10C HIGH-PERFORMANCE *IMPACT-X*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

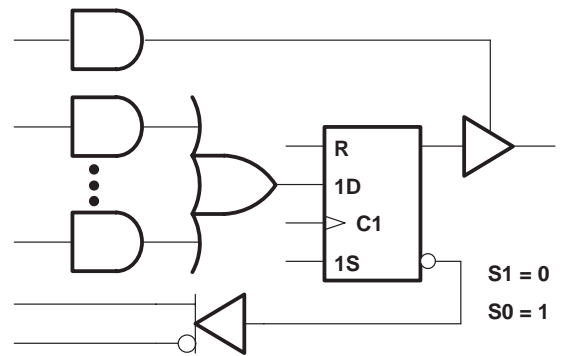
SRPS015 – D3972, FEBRUARY 1992

output logic macrocell diagram

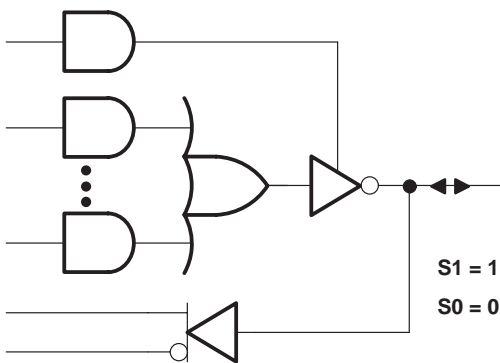




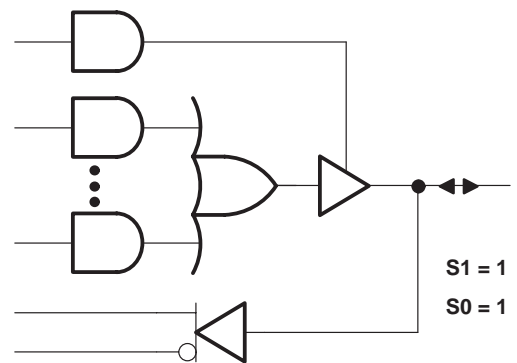
REGISTER FEEDBACK, REGISTERED, ACTIVE-LOW OUTPUT



REGISTER FEEDBACK, REGISTERED, ACTIVE-HIGH OUTPUT



I/O FEEDBACK, COMBINATIONAL, ACTIVE-LOW OUTPUT



I/O FEEDBACK, COMBINATIONAL, ACTIVE-HIGH OUTPUT

MACROCELL FEEDBACK AND OUTPUT FUNCTION TABLE

FUSE SELECT		FEEDBACK AND OUTPUT CONFIGURATION		
S1	S0			
0	0	Register feedback	Registered	Active low
0	1	Register feedback	Registered	Active high
1	0	I/O feedback	Combinational	Active low
1	1	I/O feedback	Combinational	Active high

0 = unblown fuse, 1 = blown fuse

S1 and S0 are select-function fuses as shown in the output logic macrocell diagram.

Figure 1. Resultant Macrocell Feedback and Output Logic After Programming

TIBPAL22V10-10C

HIGH-PERFORMANCE *IMPACT-X*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

SRPS015 – D3972, FEBRUARY 1992

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage (see Note 1)	–1.2 V to $V_{CC} + 0.5$ V
Voltage range applied to disabled output (see Note 1)	–0.5 V to $V_{CC} + 0.5$ V
Operating free-air temperature range	0°C to 75°C
Storage temperature range	–65°C to 150°C

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.75	5	5.25	V
V_{IH}	High-level input voltage (see Note 2)	2		5.5	V
V_{IL}	Low-level input voltage (see Note 2)			0.8	V
I_{OH}	High-level output current			–3.2	mA
I_{OL}	Low-level output current			16	mA
t_w	Pulse duration	Clock high or low		5	ns
		Asynchronous reset high or low		10	
t_{su}	Setup time before clock↑	Input		7	ns
		Feedback		7	
		Synchronous preset (active)		9	
		Synchronous preset (inactive)		8	
		Asynchronous reset (inactive)		8	
t_h	Hold time, input, set, or feedback after clock↑	0			ns
T_A	Operating free-air temperature	0		75	°C

NOTE 2: These are absolute voltage levels with respect to the ground pin of the device and includes all overshoots due to system and/or tester noise. Testing these parameters should not be attempted without suitable equipment.

electrical characteristics over recommended operating free-air temperature range

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
V _{IK}		V _{CC} = 4.75 V, I _I = –18 mA			–1.2	V
V _{OH}		V _{CC} = 4.75 V, I _{OH} = –3.2 mA	2.4			V
V _{OL}		V _{CC} = 4.75 V, I _{OL} = 16 mA		0.35	0.5	V
I _{OZH} ‡		V _{CC} = 5.25 V, V _O = 2.7 V			0.1	mA
I _{OZL} ‡		V _{CC} = 5.25 V, V _O = 0.4 V			–0.1	mA
I _I		V _{CC} = 5.25 V, V _I = 5.5 V			1	mA
I _{IH} ‡		V _{CC} = 5.25 V, V _I = 2.7 V			25	μA
I _{IL}	CLK	V _{CC} = 5.25 V, V _I = 0.4 V			–0.25	mA
	All others				–0.1	
I _{OS} §		V _{CC} = 5.25 V, V _O = 0.5 V	–30		–130	mA
I _{CC}		V _{CC} = 5.25 V, V _I = GND, Outputs open			210	mA
C _i	I	f = 1 MHz, V _I = 2 V			6	pF
	CLK				6	
C _O		f = 1 MHz, V _O = 2 V			8	pF

† All typical values are at V_{CC} = 5 V, T_A = 25°C.

‡ I/O leakage is the worst case of I_{OZL} and I_{IL} or I_{OZH} and I_{IH}, respectively.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. V_O is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITION	MIN	MAX	UNIT
f _{max} [¶]	Without feedback		R1 = 300 Ω, R2 = 300 Ω, See Figure 6	100		MHz
	With internal feedback (counter configuration)			80		
	With external feedback			71		
t _{pd}	I, I/O	I/O		1	10	ns
t _{pd}	I, I/O (reset)	Q			15	ns
t _{pd}	CLK	Q		1	7	ns
t _{pd} [#]	CLK	Feedback			5.5	ns
t _{en}	I, I/O	I/O, Q			11	ns
t _{dis}	I, I/O	I/O, Q			9	ns

$$¶ f_{\max} (\text{without feedback}) = \frac{1}{t_{w(\text{low})} + t_{w(\text{high})}}$$

$$f_{\max} (\text{with internal feedback}) = \frac{1}{t_{\text{su}} + t_{\text{pd}}(\text{CLK to feedback})}$$

$$f_{\max} (\text{with external feedback}) = \frac{1}{t_{\text{su}} + t_{\text{pd}}(\text{CLK to Q})}$$

This parameter is calculated from the measured f_{max} with internal feedback in the counter configuration.

TIBPAL22V10-10C HIGH-PERFORMANCE *IMPACT-X*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

SRPS015 – D3972, FEBRUARY 1992

preload procedure for registered outputs (see Notes 3 and 4)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below:

- Step 1. With V_{CC} at 5 V and pin 1 at V_{IL} , raise pin 13 to V_{IHH} .
- Step 2. Apply either V_{IL} or V_{IH} to the output corresponding to the register to be preloaded.
- Step 3. Pulse pin 1, clocking in preload data.
- Step 4. Remove output voltage, then lower pin 13 to V_{IL} . Preload can be verified by observing the voltage level at the output pin.

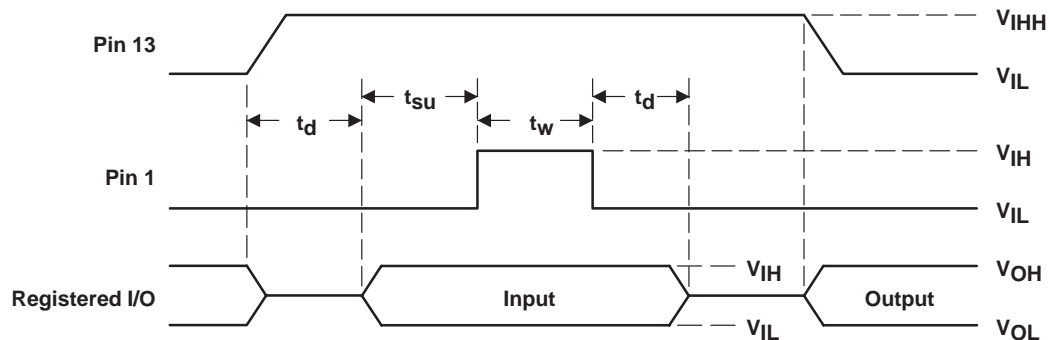


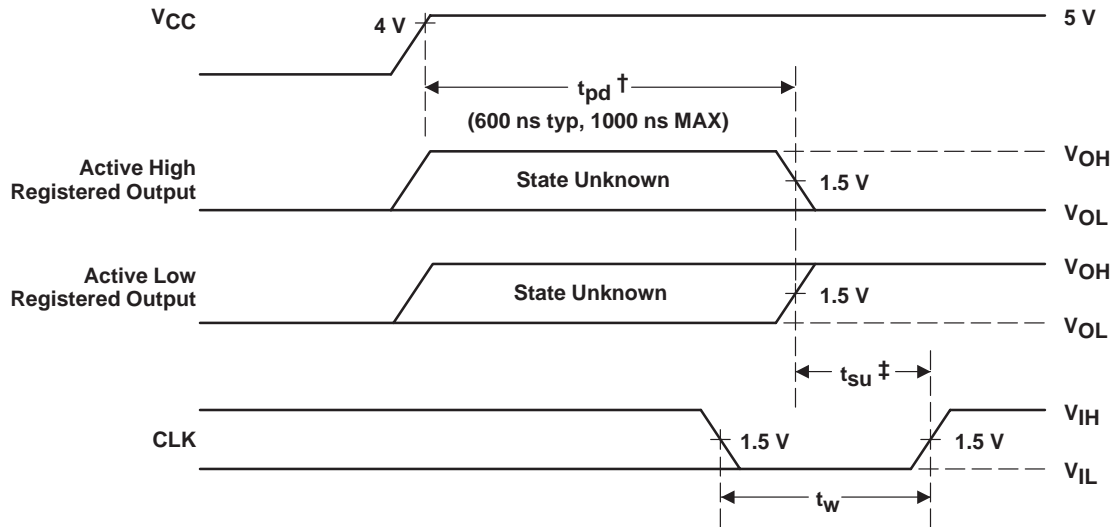
Figure 2. Preload Waveforms

NOTES: 3. Pin numbers shown are for the NT package only. If chip-carrier socket adapter is not used, pin numbers must be changed accordingly.

4. $t_d = t_{su} = t_w = 100$ ns to 1000 ns. $V_{IHH} = 10.25$ V to 10.75 V.

power-up reset

Following power up, all registers are reset to zero. The output level depends on the polarity selected during programming. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of V_{CC} be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.



† This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.

‡ This is the setup time for input or feedback.

Figure 3. Power-Up Reset Waveforms

programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

THERMAL INFORMATION

thermal management of the TIBPAL22V10-10C

Thermal management of the TIBPAL22V10-10CNT and TIBPAL22V10-10CFN is necessary when operating at certain conditions of frequency, output loading, and outputs switching simultaneously. The device and system application will determine the appropriate level of management.

Determining the level of thermal management is based on factors such as power dissipation (P_D), ambient temperature (T_A), and transverse airflow (FPM). Figures 4 (a) and 4 (b) show the relationship between ambient temperature and transverse airflow at given power dissipation levels. The required transverse airflow can be determined at a particular ambient temperature and device power dissipation level in order to ensure the device specifications.

Figure 5 illustrates how power dissipation varies as a function of frequency and the number of outputs switching simultaneously. It should be noted that all outputs are fully loaded ($C_L = 50$ pF). Since the condition of eight fully loaded outputs represents the worst-case condition, each application must be evaluated accordingly.

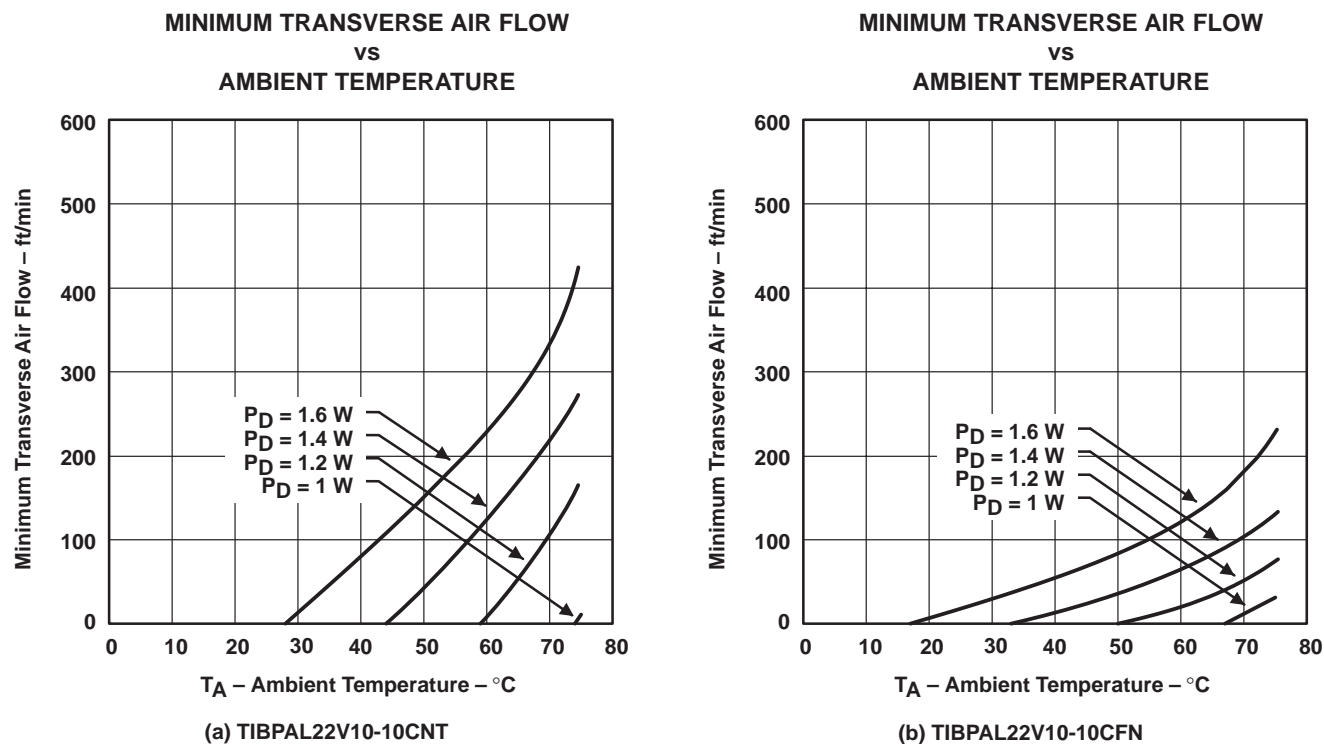


Figure 4

THERMAL INFORMATION

POWER DISSIPATION vs FREQUENCY

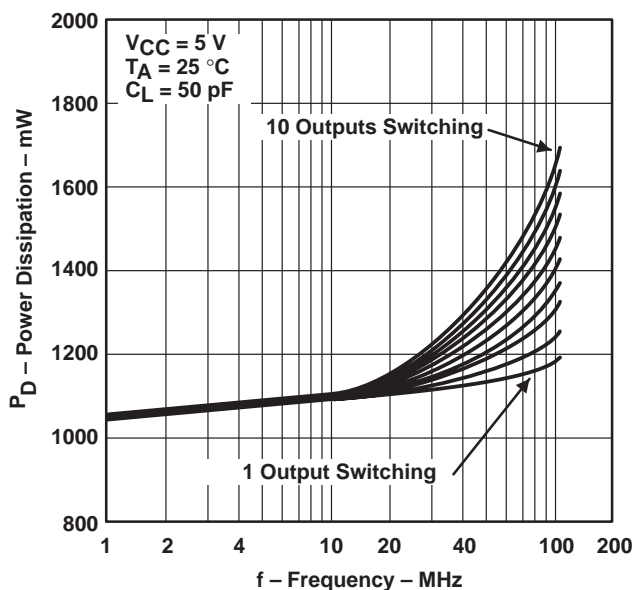
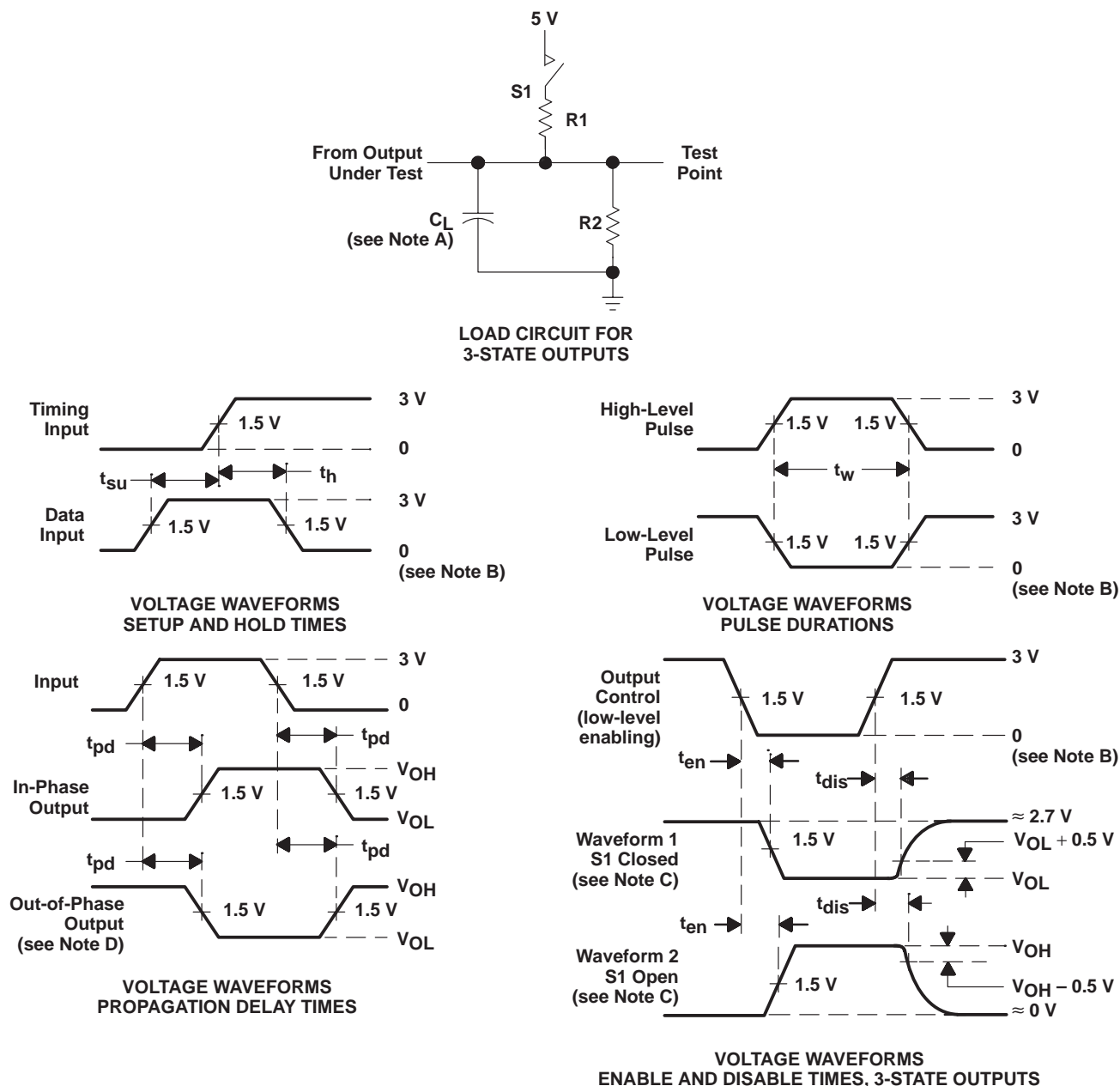


Figure 5

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .
B. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
E. Equivalent loads may be used for testing.

Figure 6. Load Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

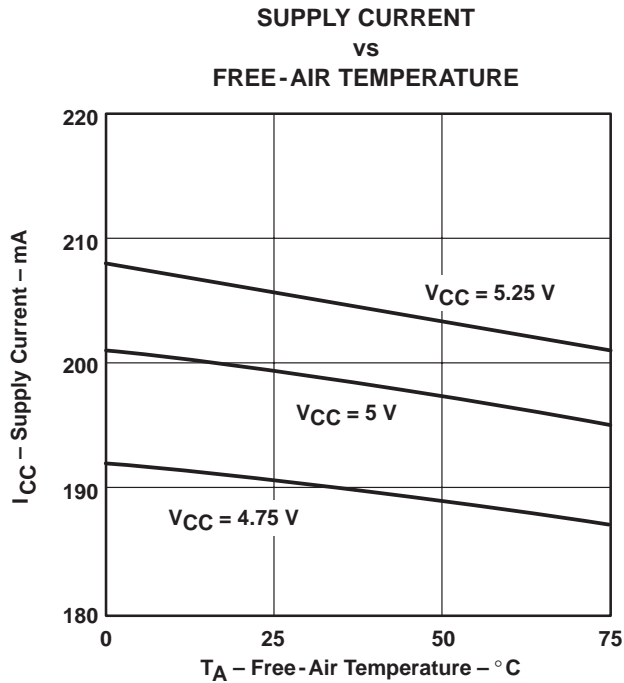


Figure 7

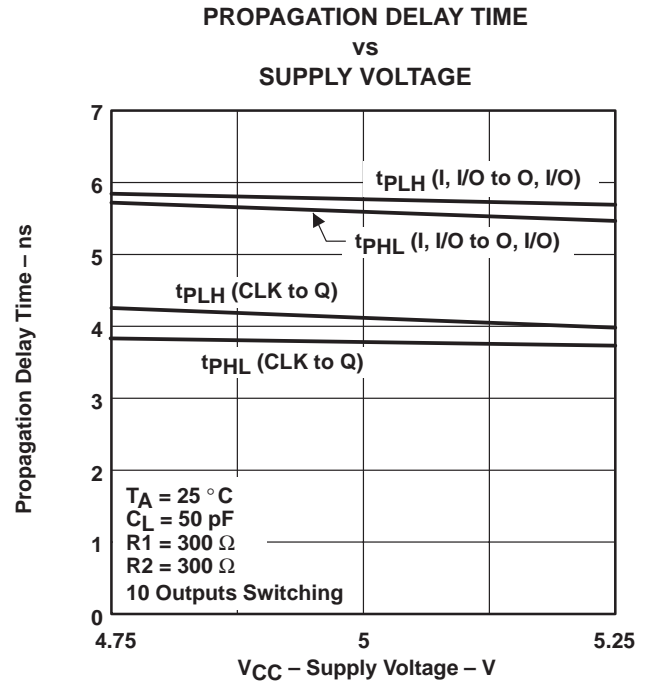


Figure 8

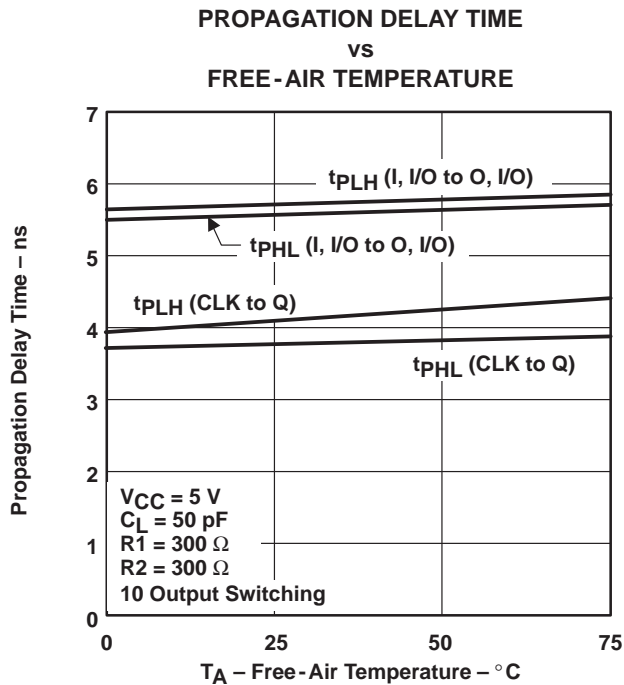


Figure 9

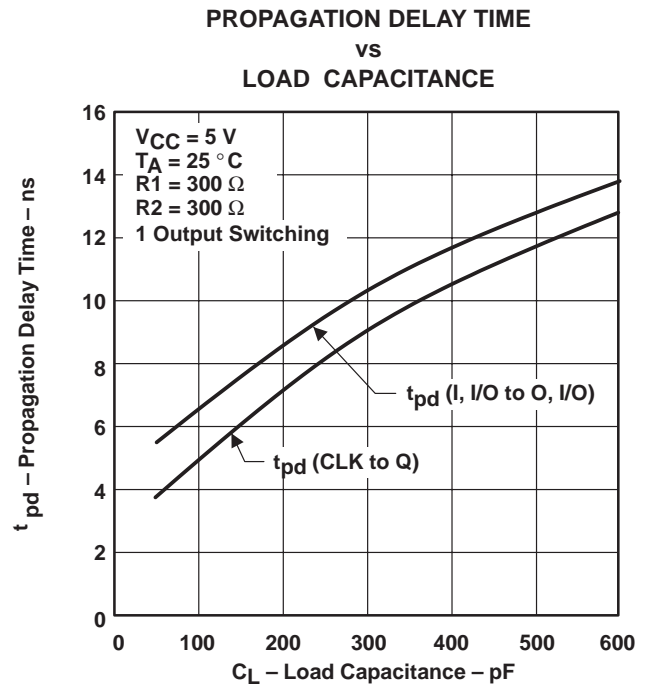


Figure 10

TYPICAL CHARACTERISTICS

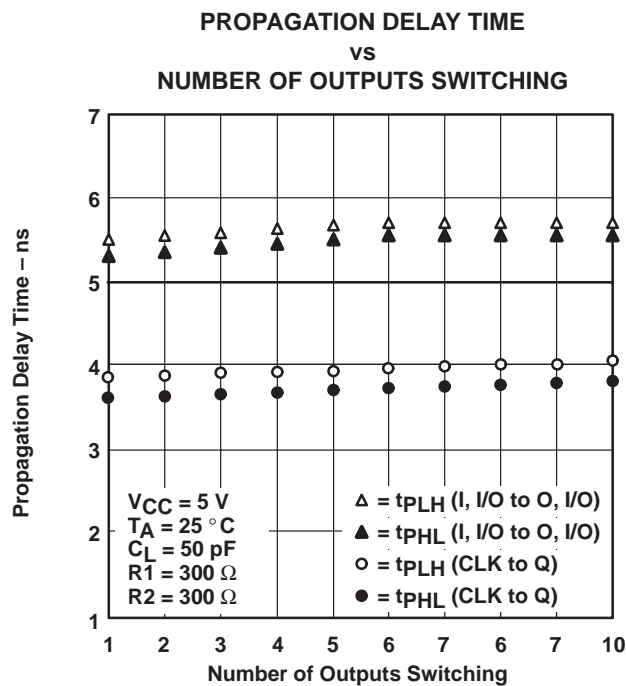


Figure 11

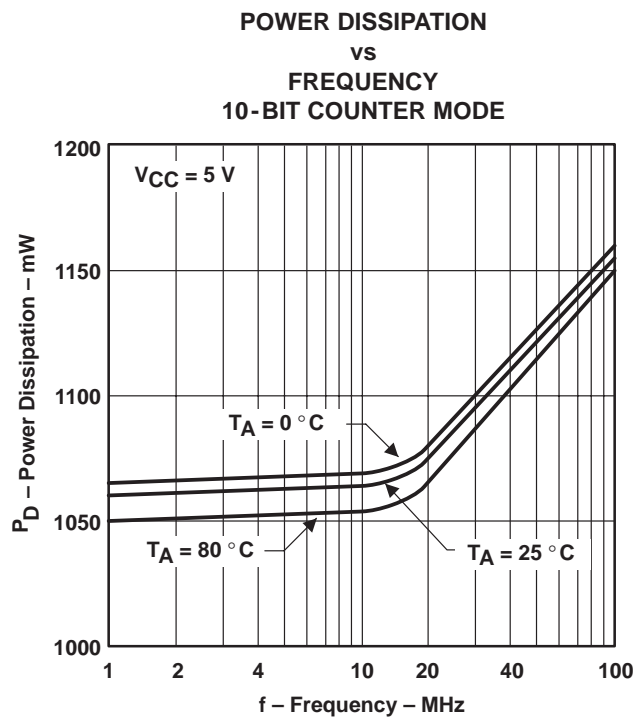


Figure 12

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.